

# Ultramid® A3EG7

## Polyamide 66 (Nylon 66)



### Product Description

Ultramid A3EG7 is a 35% glass fiber reinforced injection molding PA66 grade for machinery components and housings of high stiffness and dimensional stability.

### Applications

Typical applications include lamp socket housings, cooling fans, insulating profile for aluminium window frames, water containers for automotive cooling systems, as well as electrically insulating parts.

PHYSICAL	ISO Test Method	Property Value	
Density, g/cm <sup>3</sup>	1183	1.41	
Moisture, %	62		
(50% RH)		1.6	
(Saturation)		5	
RHEOLOGICAL	ISO Test Method	Dry	Conditioned
Melt Volume Rate (275 °C/5 Kg), cc/10min.	1133	40	
MECHANICAL	ISO Test Method	Dry	Conditioned
Tensile Modulus, MPa	527		
23°C		11,500	8,500
Tensile stress at break, MPa	527		
23°C		210	150
80°C		122	-
Tensile strain at break, %	527		
23°C		3	5
Flexural Modulus, MPa	178		
23°C		10,000	8,480
IMPACT	ISO Test Method	Dry	Conditioned
Izod Notched Impact, kJ/m <sup>2</sup>	180		
23°C		14	-
Charpy Notched, kJ/m <sup>2</sup>	179		
23°C		14	22
-30°C		12	-
Charpy Unnotched, kJ/m <sup>2</sup>	179		
23°C		95	105
-30°C		75	-
THERMAL	ISO Test Method	Dry	Conditioned
Melting Point, °C	3146	260	-
HDT A, °C	75	250	-
HDT B, °C	75	250	-
Coef. of Linear Thermal Expansion, Parallel, mm/mm °C		0.17 X10-4	-
Coef. of Linear Thermal Expansion, Normal, mm/mm °C		0.65 X10-4	-

ELECTRICAL	ISO Test Method	Property Value	
Comparative Tracking Index	IEC 60112	550	
Volume Resistivity	IEC 60093	1E13	
Surface Resistivity	IEC 60093	1E12	
Dielectric Constant (1 MHz)	IEC 60250	3.5	
Dissipation Factor (100 Hz)	IEC 60250	200	
Dissipation Factor (1 MHz)	IEC 60250	200	
UL RATINGS	ISO Test Method	Dry	Conditioned
Flammability Rating, 1.5mm	UL94	HB	
Relative Temperature Index, 1.5mm	UL746B		
Mechanical w/o Impact, °C		130	
Mechanical w/ Impact, °C		120	
Electrical, °C		120	

## Processing Guidelines

### Material Handling

Max. Water content: 0.12%

Product is supplied in sealed containers and drying prior to molding is not required. If drying becomes necessary, a dehumidifying or desiccant dryer operating at 80 °C (176 °F) is recommended. Drying time is dependent on moisture level, but 2-4 hours is generally sufficient. Further information concerning safe handling procedures can be obtained from the Material Safety Data Sheet. Alternatively, please contact your BASF representative.

### Typical Profile

Melt Temperature 280-305 °C (535-580 °F)

Mold Temperature 80-90 °C (176-194 °F)

Injection and Packing Pressure 35-125 bar (500-1500 psi)

### Mold Temperatures

A mold temperature of 80-90 °C (176-194 °F) is recommended, but temperatures of as low as 45 °C (113 °F) and as high as 105 °C (221 °F) can be used where applicable.

### Pressures

Injection pressure controls the filling of the part and should be applied for 90% of ram travel. Packing pressure affects the final part and can be used effectively in controlling sink marks and shrinkage. It should be applied and maintained until the gate area is completely frozen off.

Back pressure can be utilized to provide uniform melt consistency and reduce trapped air and gas. Minimal back pressure should be utilized to prevent glass breakage.

### Fill Rate

Fast fill rates are recommended to insure uniform melt delivery to the cavity and prevent premature freezing. Surface appearance is directly affected by injection rate.

## Note

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